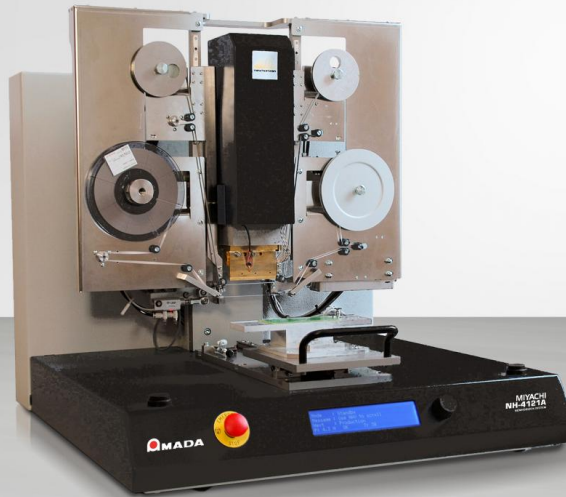




Serie NH-4000A Sistema di laminazione ACF/pre-Bonding (precedentemente conosciuto come MACFL)

Progettato per applicazioni di bonding ACF fine-pitch (> 30 micron), il laminatore ACF (Anisotropic Conductive Film) utilizza un processo a due o tre fasi per connettere materiali quali flex-foil a vetro o flex-foil a PCB. La laminazione ACF/Pre-Bonding si ottiene erogando e tagliando il nastro ACF, posizionandolo sulla superficie delle parti da connettere e spostando il thermode in posizione. Il flex viene quindi spostato in posizione per allineare le tracce al substrato e il thermode viene azionato per completare l'accoppiamento.

Key Features NH-4000 Series ACF Laminating System

- > Compact and flexible systems for high quality connections
- > Connecting displays to PCB, bonding glass panel displays and flex foils
- > User friendly system configuration, including optional plug & play modules
- > Integrated Constant Heat process control based on proven technology
- > Ideal price-performance (throughput) ratio
- > CE approved
- > Pneumatic bond head, X-Y Hot Bar planarity adjustment and electronic system control included

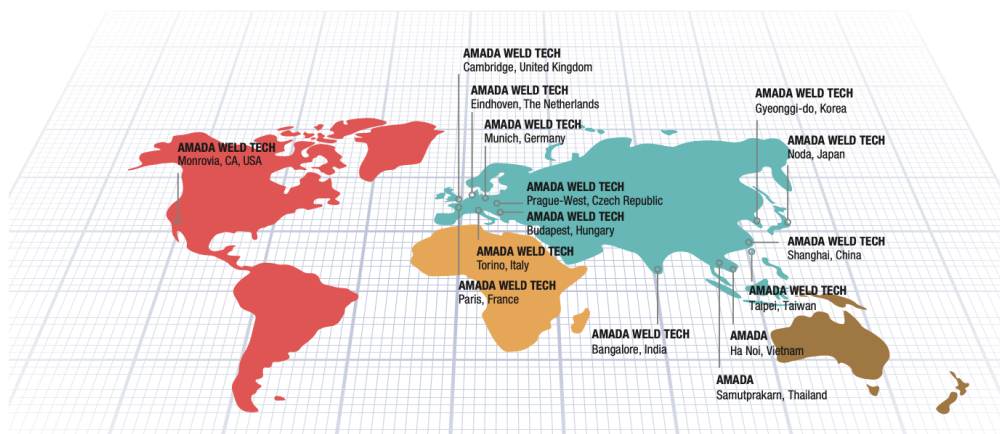
AMADA®

AMADA WELD TECH

OUR TECHNOLOGIES



OUR SALES OFFICES



AMADA WELD TECH GmbH
Lindberghstrasse 1 • DE-82178 Puchheim, Germany
T: +49 (0) 89 83 94 030 • Fax : +49 (0) 89 839403 68
info@amadaweldtech.eu • www.amadaweldtech.eu
ISO 9001 Certified Company

Please contact our worldwide
network here:



All data, images and text are subject to change at any time. AMADA WELD TECH GmbH reserves the right to change, modify, delete and add technical specifications and product details at any time without prior notification. © 2020 AMADA WELD TECH GmbH.

WWW.AMADAWELDTECH.EU